

September 20, 2012

13-027

AUTHORIZATION FOR O'NEILL/WALSH COMMUNITY BUILDERS TO PROVIDE CONSTRUCTION SERVICES FOR TWO NEW BUILDINGS FOR THE SOUTHEAST CENTER BOND CONSTRUCTION PROJECT

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FINANCIAL RESPONSIBILITY: Linda Degman, Director, Bond Program

APPROVED BY: Wing-Kit Chung, Vice President, Administrative Services
Randy McEwen, District Vice President
Dr. Preston Pulliams, District President

REPORT: With Board Resolution 12-059 the Board of Directors adopted the findings and approved the exemption to authorize the use of the CM/GC alternative contracting method for Southeast Center.

After a formal Request for Proposals process, per Resolution 12-075, the Board awarded the Construction Manager/General Contractor contract for the Southeast Center 2008 bond program to O'Neill/Walsh Community Builders, for an initial amount of \$500,000.

Much work by college leadership and stakeholders as part of the 2008 bond program to expand Southeast Center's course offerings and services have resulted in plans for two new buildings. The first building is a student commons, which includes ground floor student services functions such as admission, registration, financial aid, business office, expanded bookstore; upper floors contain new science labs, classrooms, and division office space. Additionally, the ground floor includes areas for retail opportunities. The second building includes a new library, which incorporates computer resources and tutoring, classrooms, and ground floor retail space.

The guaranteed maximum price (GMP) for the two new buildings is \$26,749,147. The student center portion is \$16,043,224, and the library building portion is

\$10,705,923. Construction is anticipated to begin October 2012.

This resolution plus the earlier authorization total \$27,249,147.

RECOMMENDATION: That the Board of Directors authorize O'Neill/Walsh Community Builders to construct the two new buildings at Southeast Center for a GMP of \$26,749,147. Funds are from the 2008 Bond Program.